CRMQTL0306A

N-Channel 30V, 4.1mΩ Typ. Power MOSFET

Description

Features

• 30V, 52A

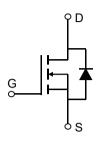
$$R_{DS(ON)}$$
 Typ = 4.1m Ω @ V_{GS} = 10V

$$R_{DS(ON)}$$
 Typ = 6.2m Ω @ V_{GS} = 4.5V

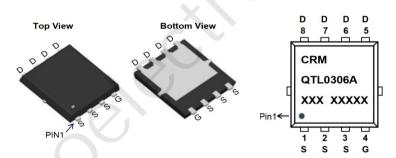
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

- Load Switch
- PWM Application
- Power Management







Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMQTL0306A	CRMQTL0306A	PDFN3.3x3.3-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ $T_J = 25$ °C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		30	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	52	Α
I _D	Continuous Diam Current	T _C = 100°C	31.2	Α
I _{DM}	Pulsed Drain Current (1)		208	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		72	mJ
P_{D}	Power Dissipation	T _C = 25°C	25	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		5	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.4	2	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 20A$	-	4.1	5.3	mΩ
		V _{GS} = 4.5V, I _D = 15A	-	6.2	8.1	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-(1916	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X - \	217	-	pF
C_{rss}	Reverse Transfer Capacitance	1 – 1101112	-	183	-	pF
Q_g	Total Gate Charge		J -	37	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_D = 30A$	-	7.4	-	nC
Q_{gd}	Gate Drain("Miller") Charge	VDS = 10 V, 10 = 00/1	-	8.6	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime	.r ()	-	8.4	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	20	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 30A$, $R_{GEN} = 3\Omega$	-	32	-	ns
t _f	Turn-Off Fall Time	>		9		ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	52	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	208	А
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 204 4:/4+ - 4004/	-	10.2	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$, di/dt = 100A/us	_	2.75	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =15V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =17A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

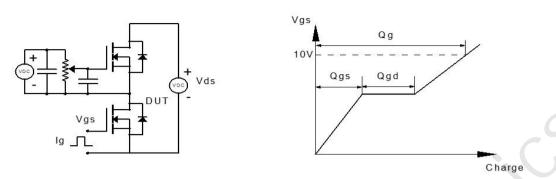


Figure 1: Gate Charge Test Circuit & Waveform

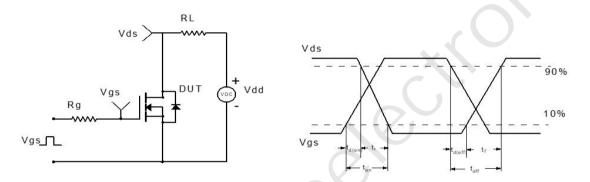


Figure 2: Resistive Switching Test Circuit & Waveform

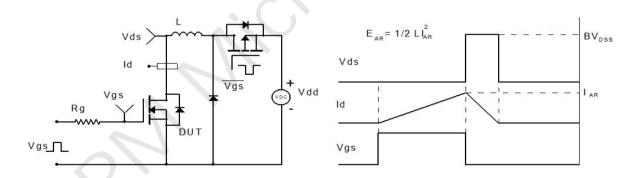


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

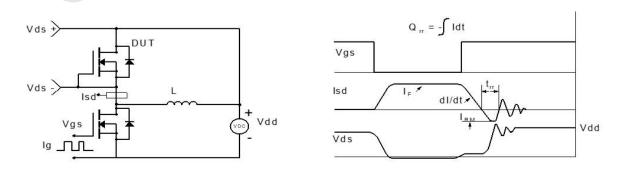
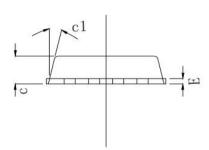


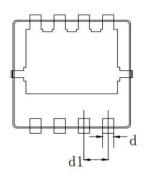
Figure 4: Diode Recovery Test Circuit & Waveform

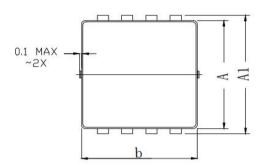
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Package Mechanical Data(PDFN3.3x3.3-8L)







COM	MON DIN	MENSION	(MM)		
PKG	PDFN 3.3×3.3-8L				
Symbol	MIN	MON	MAX		
A	3. 070	3. 100	3.130		
A1	3. 300	3, 400	3.500		
b	3. 070	3. 100	3.130		
С	0.770	0.800	0.830		
c1	13°				
d	0. 300				
d1	0. 650				
Е	0. 152				

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